

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J MOS[®] S2 series

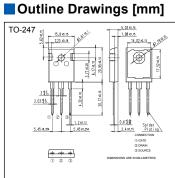
N-Channel enhancement mode power MOSFET

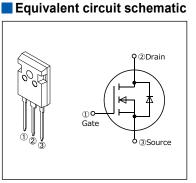
Features

Pb-free lead terminal **RoHS** compliant uses Halogen-free molding compound

Applications

For switching





Absolute Maximum Ratings at T_{vi}=25°C (unless otherwise specified)

| Parameter | Symbol | Characteristics | Unit | Remarks |
|---|----------------------|-----------------|------|---------------------------------|
| Drain Source Veltere | VDS | 600 | V | |
| Drain-Source Voltage | VDSX | 600 | V | V _{GS} =-30V |
| Continuous Drain Current | , | 47.9 | А | T _{vj} =25°C Note*1,2 |
| Continuous Drain Current | I _D | 30.3 | А | T _{vj} =100°C Note*1,2 |
| Pulsed Drain Current | I _{DP} | 148 | А | Note *2 |
| Gate-Source Voltage | Vgs | ±30 | V | |
| Non-Repetitive Maximum Avalanche Current | las | 5.5 | А | Note *3 |
| Non-Repetitive Maximum Avalanche Energy | Eas | 1177 | mJ | Note *4 |
| Maximum Drain-Source dV/dt | dV _{DS} /dt | 50 | V/ns | V _{DS} ≤ 600V |
| Continuous | , | 47.9 | А | T _{vj} =25°C Note*1,2 |
| Diode Forward Current | Isd | 30.3 | А | T _{vj} =100°C Note*1,2 |
| Pulsed Diode Forward Current | Isdp | 148 | А | Note *2 |
| Peak Diode Recovery dV/dt | dV/dt | 15 | V/ns | Note *5 |
| Peak Diode Recovery -di/dt | -di/dt | 100 | A/µs | Note *6 |
| Maximum Dawar Disaination | D | 2.50 | 10/ | <i>T</i> ₂=25°C |
| Maximum Power Dissipation | PD | 235 | W | <i>T</i> _{vj} =25°C |
| Oneverting and Stevens Temperature renge | Tch | 150 | °C | |
| Operating and Storage Temperature range | T stg | -55 to +150 | °C | |

Note *1 : Maximum duty cycle D=0.60

Note *1: Imited by maximum channel temperature. Note *3: T_{ch}≤150°C, See Fig.1 and Fig.2 Note *4: Starting T_{oh}=25°C, I_As=3.3A, L=198mH, V_{DD}=60V, R_G=50Ω, See Fig.1 and Fig.2 E_{AS} limited by maximum channel temperature and avalanche current. Note *5: I_{SD}≤37.1A, -di/dt≤100A/µs, V_{DS peak}≤600V, T_{ch}≤150°C. Note *6: I_{SD}≤37.1A, dV/dt≤15V/ns, V_{DS peak}≤600V, T_{ch}≤150°C.

Electrical Characteristics at T_{vj}=25°C (unless otherwise specified) Static Ratings

| Parameter | Symbol | Conditions | | Min. | Тур. | Max. | Unit |
|----------------------------------|---------------------|---|-------------------------------|------|-------|-------|------|
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{ss} =0V /₀=250µA | | 600 | - | - | V |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} I₀=1.95mA | | 3.5 | 4.0 | 4.5 | V |
| Zero Gate Voltage Drain Current | loss | V _{DS} =600V V _{GS} =0V | T _{ch} =25°C | - | - | 25 | μA |
| | | V _{DS} =480V V _{GS} =0V | <i>T</i> _{ch} =125°C | - | - | 250 | |
| Gate-Source Leakage Current | Igss | V _{DS} =0V V _{GS} =±30V | | - | 10 | 100 | nA |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} =10V I _D =18.6A | | - | 0.071 | 0.079 | Ω |
| Gate resistance | RG | f=1MHz, open drain | | - | 7.2 | - | Ω |

Dynamic Ratings

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|---|---------------------------|---|------|------|------|------|
| Forward Transconductance | g fs | V _{DS} =25V I _D =18.6A | 12.2 | 24.5 | - | S |
| Input Capacitance | Ciss | V _{DS} =400V | - | 2030 | - | |
| Output Capacitance | Coss | V _{GS} =0V | - | 67 | - | |
| Reverse Transfer Capacitance | Crss | f=250kHz | - | 8.7 | - | |
| Effective output capacitance, energy related (Note *7) | Co(er) | V _{DS} =0400V V _{GS} =0V | - | 158 | - | pF |
| Effective output capacitance, time related (Note *8) | C _{o(tr)} | V _{DS} =0400V V _{GS} =0V I _D =constant | - | 633 | - | |
| Turn-On Time | t _{d(on)} | V_{OD} =400V, V_{GS} =10V I_{D} =18.6A, R_{G} =12 Ω See Fig.3 and Fig.4 | - | 28 | - | - ns |
| | tr | | - | 98 | - | |
| Town Off Time | t _{d(off)} | | - | 140 | - | |
| Turn-Off Time | ti | | - | 26 | - | |
| Total Gate Charge | QG | | - | 80 | - | nC |
| Gate-Source Charge | Q _{GS} | V _{DD} =400V, V _{GS} =10V −I _D =37.1A See Fig.5 | - | 29 | - | |
| Gate-Drain Charge | QGD | | - | 34 | - | |
| Drain-Source crossover Charge | Qsw | | - | 18 | - | |

Note *7 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V. Note *8 : $C_{0(er)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400V.

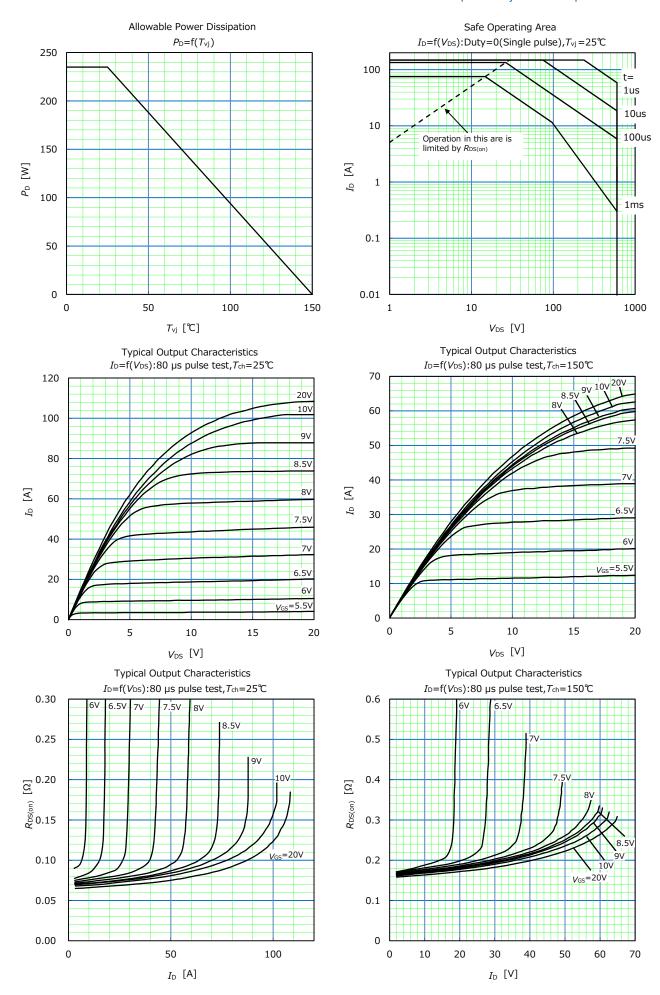
Reverse Diode

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|-------------------------------|-----------------|--|------|------|------|------|
| Diode Forward On-Voltage | V _{SD} | I _{SD} =37.1A, V _{GS} =0V T _{ch} =25°C | - | 0.90 | 1.35 | V |
| Reverse Recovery Time | trr | - V _{oo} =400V, / _{so} =37.1A -di/dt=100A/μs <i>T</i> _{ch} =25°C See Fig.6 and Fig.7 | - | 380 | - | ns |
| Reverse Recovery Charge | Qrr | | - | 6.6 | - | μC |
| Peak Reverse Recovery Current | I rp | | - | 34 | - | А |

Thermal Resistance

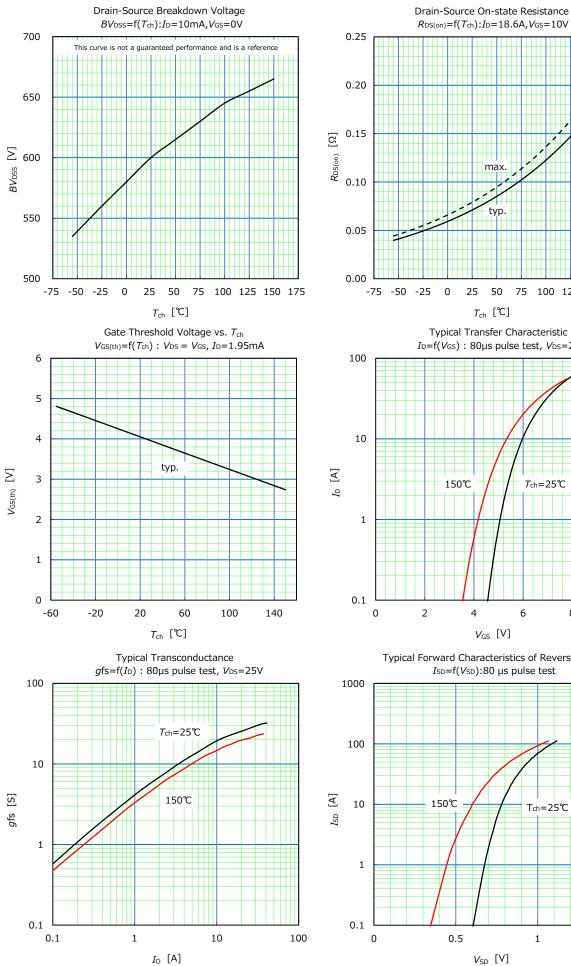
| Parameter | Symbol | Min. | Тур. | Max. | Unit |
|--------------------|-----------|------|------|-------|------|
| Channel to Case | Rth(ch-c) | - | - | 0.532 | °C/W |
| Channel to Ambient | Rth(ch-a) | - | - | 50 | °C/W |

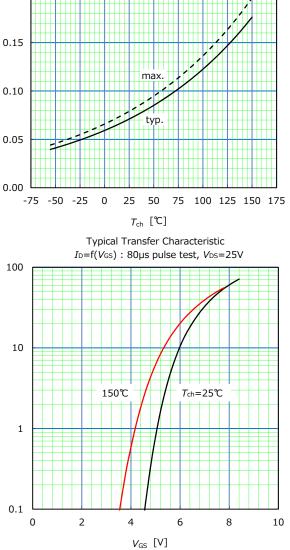
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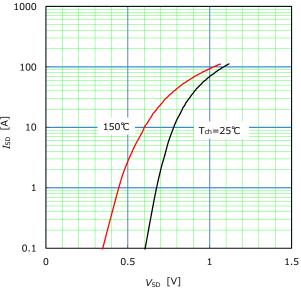
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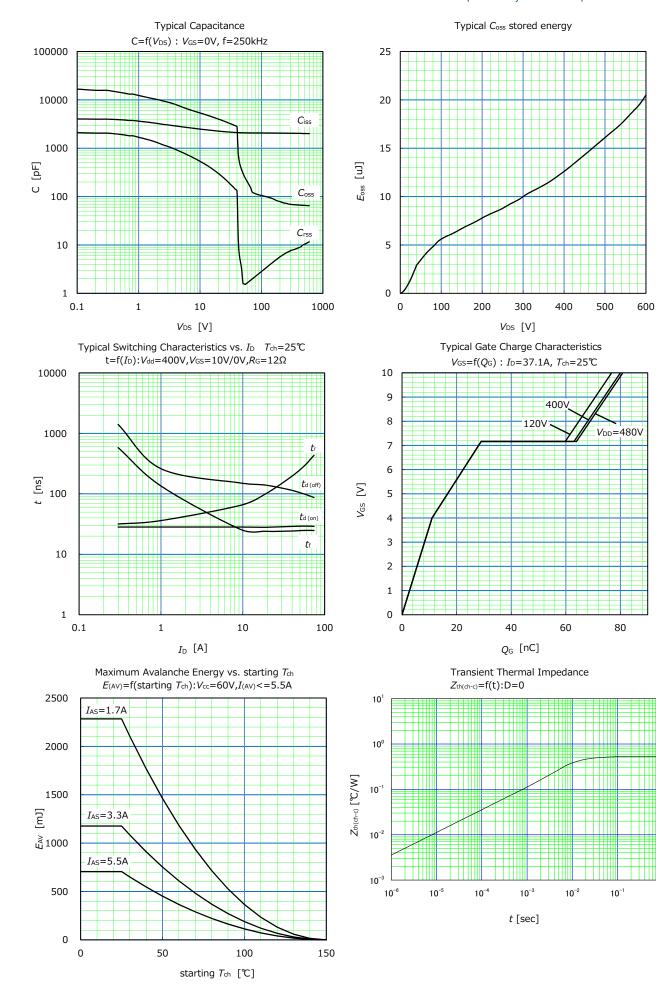
Typical Forward Characteristics of Reverse Diode $I_{SD}=f(V_{SD}):80 \ \mu s \ pulse \ test$



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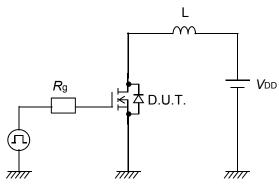


Fig.1 Avalanche Test circuit

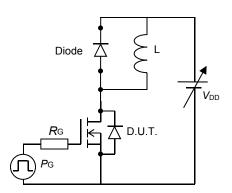


Fig.3 Switching Test circuit



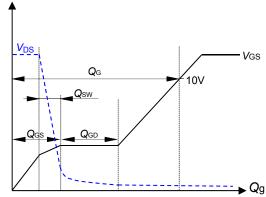
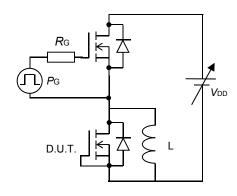
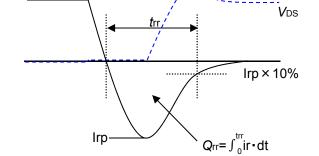


Fig.5 Operating waveform of Gate charge Test





. VDS peak

Fig.6 Reverse recovery Test circuit

Fig.7 Operating waveform of Reverse recovery Test

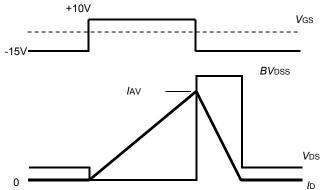


Fig.2 Operating waveforms of Avalanche Test

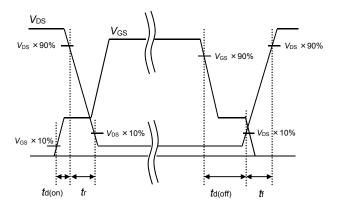


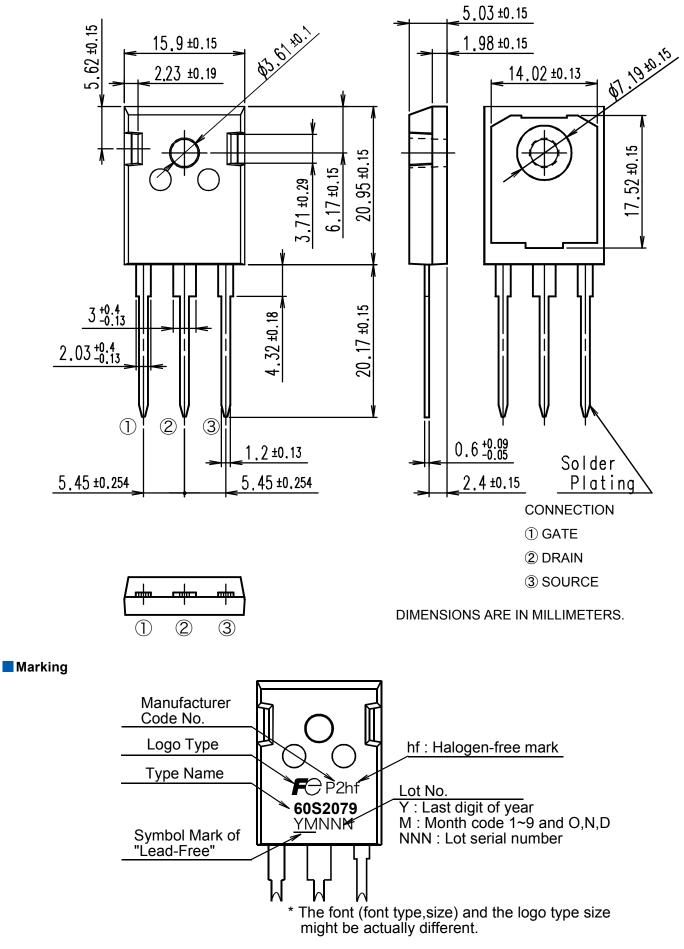
Fig.4 Operating waveform of Switching Test

Isd

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Outview: TO-247 Package



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